

## 300mW, PNP Small Signal Transistor

### FEATURES

- AEC-Q101 qualified
- High current
- Low power loss, high efficiency
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

### APPLICATIONS

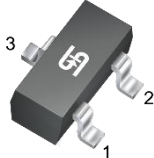
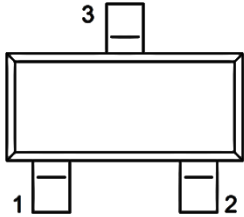
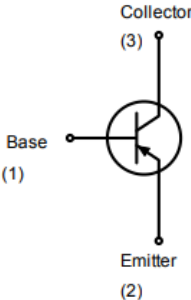
- General switching and amplification

### MECHANICAL DATA

- Case: SOT-23
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Weight: 8.00mg (approximately)



KEY PARAMETERS		
PARAMETER	VALUE	UNIT
$V_{CBO}$	-50	V
$V_{CEO}$	-45	V
$V_{EBO}$	-5	V
$I_C$	-500	mA
$h_{FE}$	400-600	
Configuration	Single die	

PACKAGE: SOT-23	PIN CONFIGURATION	CIRCUIT DIAGRAM
		

ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	VALUE	UNIT
Power dissipation <sup>(1)</sup>	$P_D$	300	mW
Collector-base voltage	$V_{CBO}$	-50	V
Collector-emitter voltage	$V_{CEO}$	-45	V
Emitter-base voltage	$V_{EBO}$	-5	V
Collector current	$I_C$	-500	mA
Junction temperature	$T_J$	-55 to +150	$^\circ\text{C}$
Storage temperature	$T_{STG}$	-55 to +150	$^\circ\text{C}$

#### Note:

1. Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint

**THERMAL PERFORMANCE**

PARAMETER	SYMBOL	TYP	UNIT
Junction-to-ambient thermal resistance <sup>(1)</sup>	$R_{\theta JA}$	417	°C/W

**Thermal Performance Note:**

1. Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint

**ELECTRICAL SPECIFICATIONS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Collector-base breakdown voltage	$I_C = -10\mu\text{A}$ , $I_E = 0\text{A}$	$V_{(BR)CBO}$	-50	-	-	V
Collector-emitter breakdown voltage	$I_C = -10\text{mA}$ , $I_B = 0\text{A}$	$V_{(BR)CEO}$	-45	-	-	V
Emitter-base breakdown voltage	$I_E = -1\mu\text{A}$ , $I_C = 0\text{A}$	$V_{(BR)EBO}$	-5	-	-	V
Collector-base cut-off current	$V_{CB} = -45\text{V}$ , $I_E = 0\text{A}$	$I_{CBO}$	-	-	-0.1	$\mu\text{A}$
Emitter-base cut-off current	$V_{EB} = -4\text{V}$ , $I_C = 0\text{A}$	$I_{EBO}$	-	-	-0.1	$\mu\text{A}$
DC current gain	$V_{CE} = -1\text{V}$ , $I_C = -100\text{mA}$	BC807-25H	160	-	400	-
		BC807-40H	250	-	600	
	$V_{CE} = -1\text{V}$ , $I_C = -500\text{mA}$		40	-	-	
Collector-emitter saturation voltage	$I_C = -500\text{mA}$ , $I_B = -50\text{mA}$	$V_{CE(sat)}$	-	-	-0.7	V
Base-emitter saturation voltage	$I_C = -500\text{mA}$ , $I_B = -50\text{mA}$	$V_{BE(sat)}$	-	-	-1.2	V
Base-emitter voltage	$V_{CE} = -1\text{V}$ , $I_C = -500\text{mA}$	$V_{BE}$	-	-	-1.2	V
Transition frequency	$V_{CE} = -5\text{V}$ , $I_C = -10\text{mA}$ , $f = 100\text{MHz}$	$f_T$	100	-	-	MHz
Output capacitance	$V_{CB} = -10\text{V}$ , $I_E = 0\text{A}$ , $f = 1\text{MHz}$	$C_{obo}$	-	7	-	pF

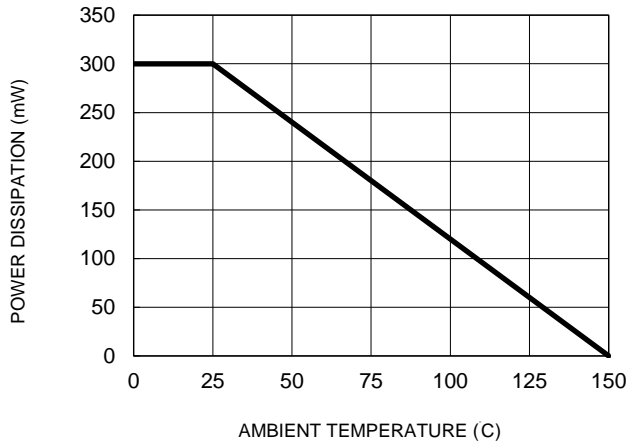
**ORDERING AND MARKING INFORMATION**

ORDERING CODE	PACKAGE	PACKING	DEVICE MARKING
BC807-25H RFG	SOT-23	3,000 / 7" Tape & Reel	<u>5</u> B
BC807-40H RFG	SOT-23	3,000 / 7" Tape & Reel	<u>5</u> C

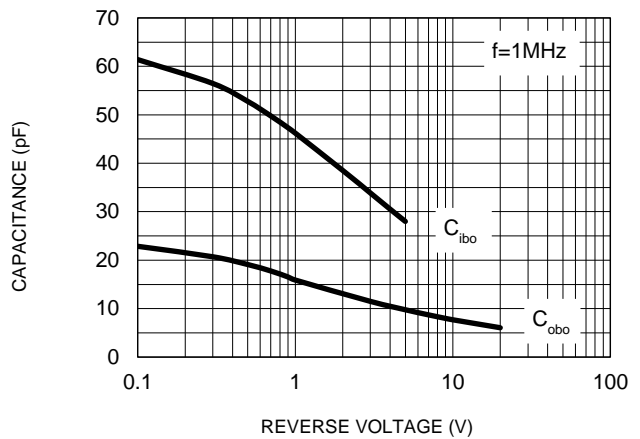
## CHARACTERISTICS CURVES

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

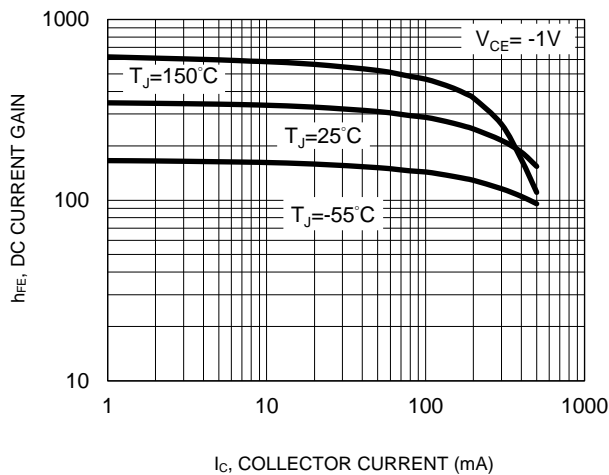
**Fig.1 Power Dissipation Curve**



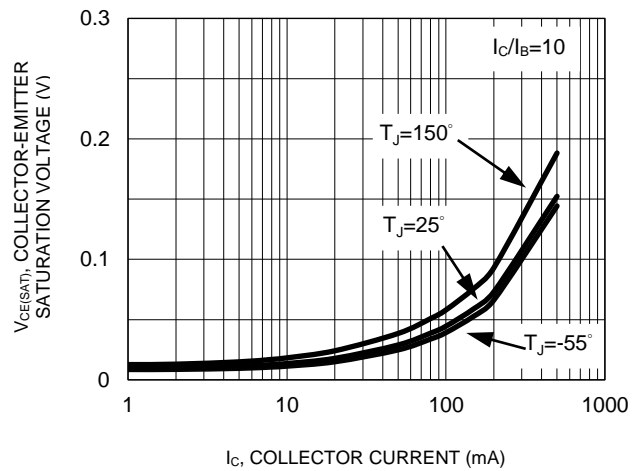
**Fig.2 Typical Capacitance Characteristics**



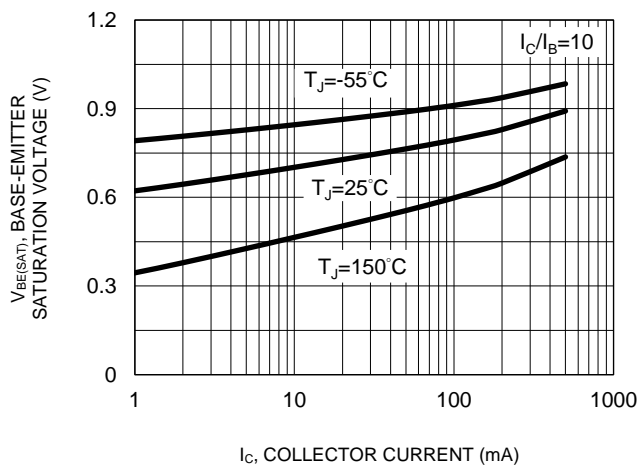
**Fig.3 DC Current Gain vs. Collector Current**



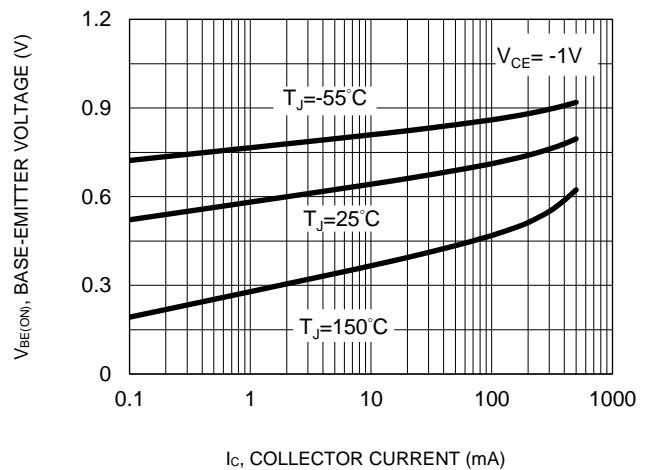
**Fig.4 Collector-Emitter Saturation Voltage vs. Collector Current**



**Fig.5 Base-Emitter Saturation Voltage vs. Collector Current**

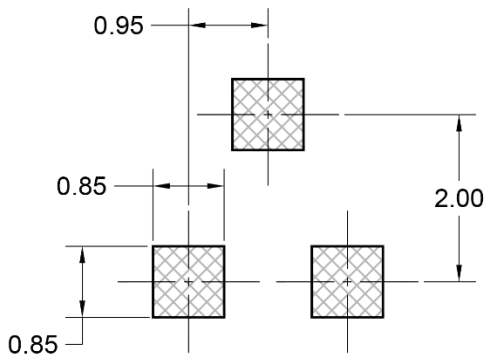
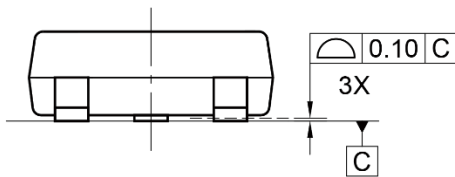
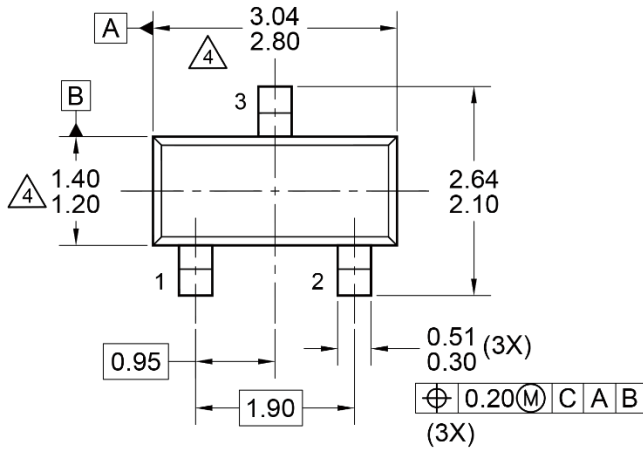


**Fig.6 Base-Emitter Voltage vs. Collector Current**

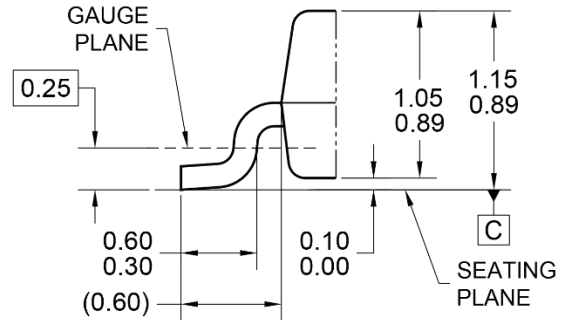


## PACKAGE OUTLINE DIMENSIONS

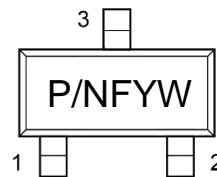
### SOT-23



SUGGESTED PAD LAYOUT



DETAIL A, ROTATED -90°  
(SCALE 2:1)



MARKING DIAGRAM

#### NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
3. PACKAGE OUTLINE REFERENCE: JEDEC TO-236, ISSUE H, VARIATION AA.
4. MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
5. DWG NO. REF: HQ2SD07-SOT23JEDEC-104 REV B.

- P/N = Device marking  
F = Factory code  
Y = Year code  
W = Bi-Week code (A~Z)

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